

01-05-2006



-40 10/537721

103151913

PATENTS ONLY

JC20 Rec'd PCT/PTO 07 JUN 2005

FROMMER LAWRENCE & HAUG LLP
745 Fifth Avenue
New York, New York 10151
(212) 588-0800

Attorney Docket No. 450100-05302

Applicants:

Michinobu YANAGISAWA, Hirokuni MIYAI, Takuya
NAKAJYOU, Hiroki UENO

For:

SLIDING COVER AND ELECTRONIC DEVICE HAVING
SLIDING COVER

U.S. Serial No.:

Filed Concurrently Herewith

Corresponding International Application. No.:

PCT/JP04/015200

International Filing Date:

October 7, 2004

Mail Stop PCT

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

1. Names of Conveying Parties:

Michinobu YANAGISAWA, Hirokuni MIYAI, Takuya
NAKAJYOU, Hiroki UENO

2. Names and addresses of receiving parties:

SONY CORPORATION
7-35 Kitashinagawa 6-chome
Shinagawa-Ku, Tokyo 141-0001, Japan

3. Nature of Conveyance:

Assignment

Execution Date(s):

March 16, March 16, March 16 and March 17, 2005

4. ☐ Application No.:

☒ This document is being filed together with a new application, the execution date of the application is:
March 16, March 16, March 16 and March 17, 2005

5. Name and address of party to whom the recorded assignment and any correspondence concerning the document should be mailed:

William S. Frommer
Registration No. 25,506
FROMMER LAWRENCE & HAUG LLP
745 Fifth Avenue
New York, New York 10151

6. Total number of applications and patents involved: 1

7. Total Fee (37 CFR 3.41):

\$40.00

☒ Fee enclosed.

8. ☐ Charge Fee Deposit Account No. 50-0320 (Attach duplicate copy of this page if paying by deposit account).

☐ If any additional fee is required, authorization is hereby given to charge Deposit Account No. 50-0320.

9. Statement and Signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

William S. Frommer

Name of Person Signing

Signature

June 7, 2005

Date

00286268

PATENT
REEL: 017414 FRAME: 0055

ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

SLIDING COVER AND ELECTRONIC DEVICE HAVING SLIDING COVER

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow:

International Application No. PCT/JP04/015200

This assignment executed on the dates indicated below.

International Filing Date:

Michinobu YANAGISAWA

October 7, 2004

Name of first or sole inventor
Kanagawa, Japan

Execution date of U.S. Patent Application

Residence of first or sole inventor

Michinobu Yanagisawa

Signature of first or sole inventor

March 16, 2005

Date of this assignment

Hirokuni MIYAI

Name of second inventor
Tokyo, Japan

Execution date of U.S. Patent Application

Residence of second inventor

Hirokuni Miyai

Signature of second inventor

March 16, 2005

Date of this assignment

Takuya NAKAJYOU

Name of third inventor
Chiba, Japan

Execution date of U.S. Patent Application

Residence of third inventor

Takuya Nakajyou

Signature of third inventor

2005-3-16

Date of this assignment

ADDITIONAL INVENTOR(S) ON NEXT PAGE

Hiroki UENO

Name of fourth inventor Tokyo, Japan	Execution date of U.S. Patent Application
Residence of fourth inventor <i>Hiroki Ueno</i>	<i>March 17, 2005</i>
Signature of fourth inventor	Date of this assignment

Name of fifth inventor	Execution date of U.S. Patent Application
Residence of fifth inventor	
Signature of fifth inventor	Date of this assignment

Name of sixth inventor	Execution date of U.S. Patent Application
Residence of sixth inventor	
Signature of sixth inventor	Date of this assignment

Name of seventh inventor	Execution date of U.S. Patent Application
Residence of seventh inventor	
Signature of seventh inventor	Date of this assignment

Name of eighth inventor	Execution date of U.S. Patent Application
Residence of eighth inventor	
Signature of eighth inventor	Date of this assignment

Name of ninth inventor	Execution date of U.S. Patent Application
Residence of ninth inventor	
Signature of ninth inventor	Date of this assignment